

Texas Instruments

# Power Management Solutions for Defense and Aerospace





























Rich Nowakowski  
Marketing Manager // Power Management

September 2017

## Most Popular Power Links:

- [Power portal](http://www.ti.com/power) www.ti.com/power
- [DC/DC portal](http://www.ti.com/dcdc) www.ti.com/dcdc
- [LDO portal](http://www.ti.com/lldo) www.ti.com/lldo

# Broad power management portfolio

 <h2>LDO Regulators</h2> <ul style="list-style-type: none"><li>• <u>Single Channel LDO</u> </li><li>• <u>Multi-Channel LDO</u> </li><li>• <u>LDO Controller (External FET)</u></li></ul>	 <h2>DC/DC Regulators</h2> <ul style="list-style-type: none"><li>• <u>Converter (Integrated Switch)</u> </li><li>• <u>Controller (External Switch)</u> </li><li>• <u>Charge Pump</u></li></ul>	 <h2>Power Modules</h2> <ul style="list-style-type: none"><li>• <u>Non-isolated module</u><ul style="list-style-type: none"><li>• <u>Step-down (buck)</u> </li><li>• <u>Step-up (boost)</u> </li><li>• <u>Buck/boost &amp; negative output module</u> </li></ul></li><li>• <u>Isolated module</u></li></ul>	 <h2>Power MOSFETs</h2> <ul style="list-style-type: none"><li>• <u>N-Channel MOSFET Transistor</u> </li><li>• <u>P-Channel MOSFET Transistor</u> </li><li>• <u>Power MOSFET Module</u></li></ul>	 <h2>IGBT, MOSFET Gate Drives</h2> <ul style="list-style-type: none"><li>• <u>Low-side Driver</u></li><li>• <u>Half-bridge Driver</u></li><li>• <u>Isolated Gate Driver</u></li></ul>
 <h2>Offline and Isolated DC/DC</h2> <ul style="list-style-type: none"><li>• <u>PWM and Resonant Controller</u> </li><li>• <u>Flyback Controller</u> </li><li>• <u>Offline Converter</u> </li><li>• <u>Isolated DC/DC</u> </li><li>• <u>Synchronous Rectifier</u></li></ul>	 <h2>AC/DC Solutions</h2> <ul style="list-style-type: none"><li>• <u>Power Factor Correction</u></li><li>• <u>Digital power</u></li></ul>	 <h2>Battery Management</h2> <ul style="list-style-type: none"><li>• <u>Battery chargers</u> </li><li>• <u>Wireless power</u></li><li>• <u>Fuel gauges, monitors</u></li><li>• <u>Protection &amp; authentication</u></li><li>• <u>Energy harvesting</u></li></ul>	 <h2>Power Special Functions</h2> <ul style="list-style-type: none"><li>• <u>NVSRAM (Non-Volatile SRAM)</u></li><li>• <u>Schottky Diode Array</u></li><li>• <u>DDR Memory Power</u> </li><li>• <u>LED lighting</u> </li><li>• <u>Interface Controlled Pre-FET Drivers</u></li></ul>	 <h2>Other</h2> <ul style="list-style-type: none"><li>• <u>Power Protection, Distribution, Monitoring</u></li><li>• <u>USB Power</u></li><li>• <u>Supervisor and Reset</u></li><li>• <u>PMICs</u></li><li>• <u>Power Multiplexer (MUX)</u></li></ul>

 [WEBENCH® design tools available http://webench.ti.com](http://webench.ti.com)

# 6 Design Challenges for Defense / Aerospace

1. **Easy to Use / Small Solution Size for POL**
2. **Low Noise Power for Signal Chain Power**
3. **Voltage Regulation Accuracy for FPGA Power**
4. **Achieving High Power Density with GaN**
5. **Enhanced Products for Environmental Extremes**
6. **Simulating your Power Design**

## Challenge #1: Designing High Power Density that's Easy to Use!



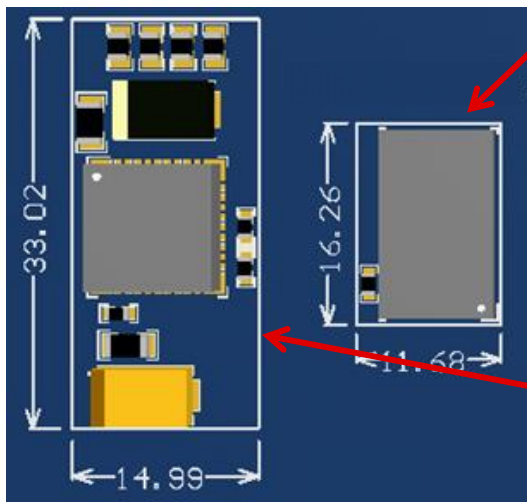
- Product value is in IP developed to improve functionality, not always the power management solution
- An experienced power designer is needed to match board space of today's over-molded power modules
- If discrete designs are not routed and optimized properly, they can have noise & EMI problems

**How much is your board space worth?**

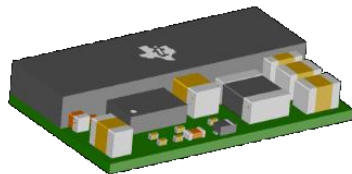
# Solution: Smallest 10A Power Module



TPSM84A21: 12Vin, 10A, 4MHz Step Down Power Module Integrates Cin & Cout

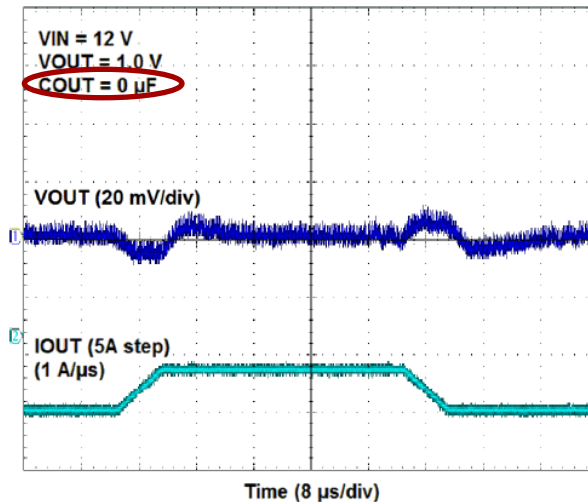


Total solution using  
TPSM84A21



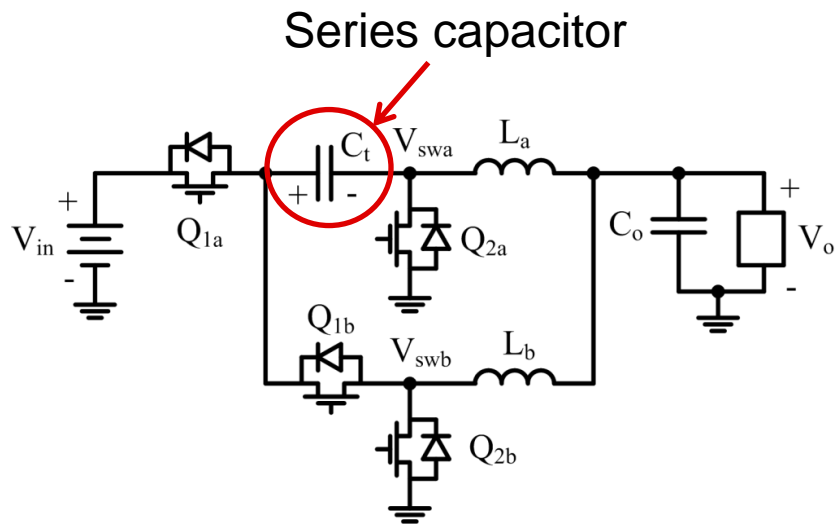
Total solution using  
traditional 10A module

Transient Response



Integrated input and output capacitors make the total solution size **over 60% smaller** than similar competitive 10A modules. Only one resistor required.

# High Density: Series Capacitor Buck Topology



Two-phase, series cap buck converter:

- [TPS54A20](#) Converter & [TPSM84A21](#) Module
- Series Capacitor App Note: <http://www.ti.com/lit/pdf/slva750>
- Development Boards: <http://www.ti.com/tool/tps54a20evm-770>
- <http://www.ti.com/tool/tpsm84a21evm-808>
- Spice Model: <http://www.ti.com/product/TPS54A20/toolssoftware>

## ✓ Benefits

- ✓ Single conversion stage
- ✓ Switching at reduced  $V_{ds}$
- ✓ Series cap soft charge/discharge
- ✓ Automatic current balancing
- ✓ Duty ratio doubled

## • Drawbacks

- 50% duty cycle limitation
  - Theoretical:  $V_{IN,MIN} = 4 \times V_{OUT}$
  - Practical:  $V_{IN,MIN} = 5 \times V_{OUT}$
- No phase shedding

# TI's Power Module Portfolio

Advanced Info

Extended Temp Range



Embedded

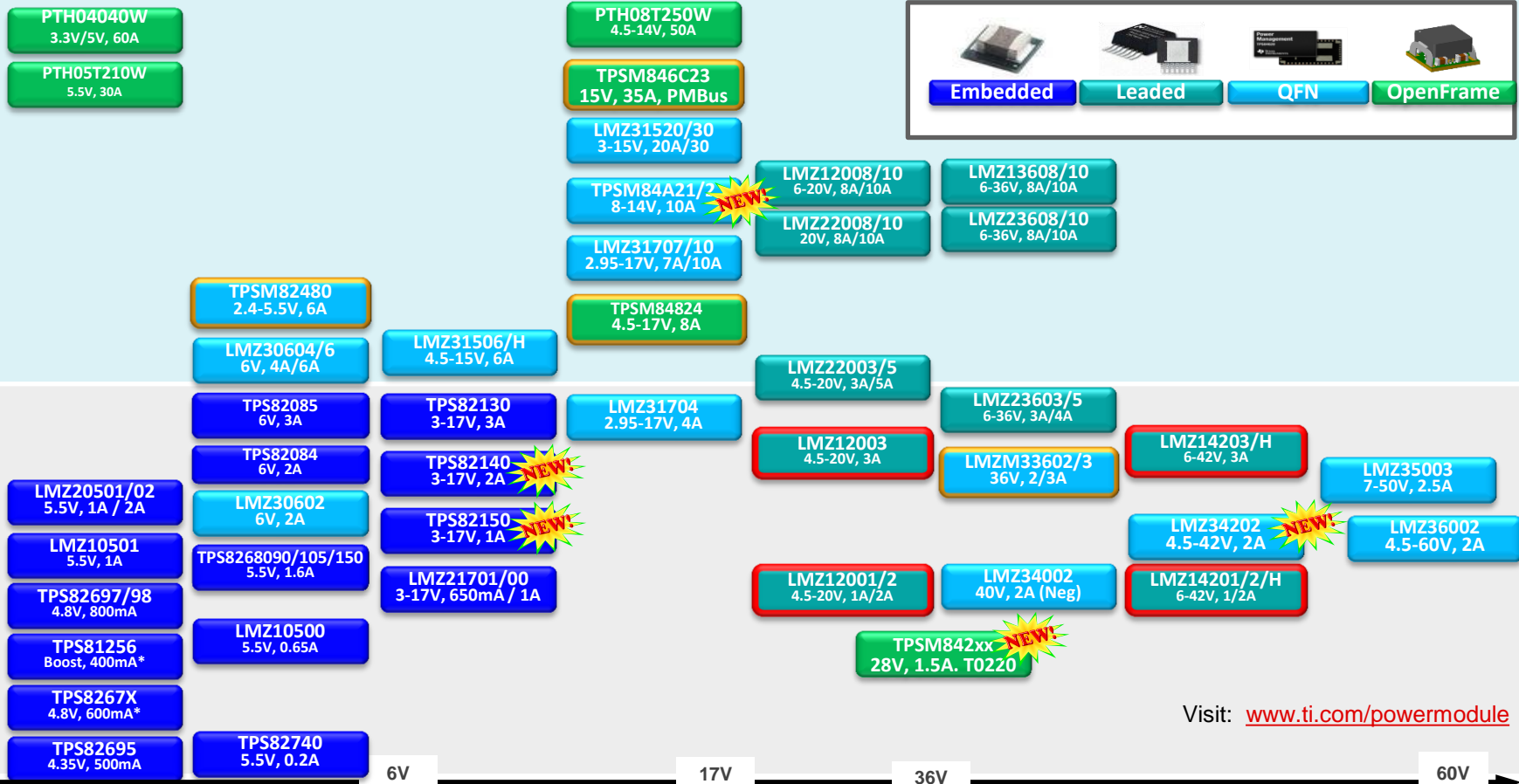
Leaded

QFN

OpenFrame

Output Current >4A

Output Current <4A



Visit: [www.ti.com/powermodule](http://www.ti.com/powermodule)

## Challenge #2: Power Supply Noise Affecting Data Converters

The most important aspect of communication systems is their ability to transfer large amounts of data quickly and is measured by the system's data capacity which is determined by the fidelity of data signals (SNR).

A system's data capacity is set by:

- $C = B \cdot \log_2(1 + \text{SNR})$  - Shannon's equation

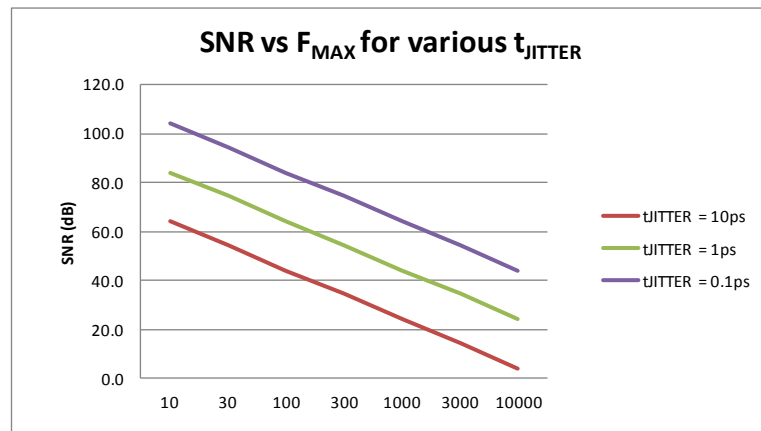
For ADC and DAC in communication systems:

- $\text{SNR} = 20 \log[1 / 2\pi \times f_{\text{MAX}} \times t_{\text{JITTER}}]$

Typical values for PSR for data converters are 40-60dB in the 100kHz to 1MHz range. This means **40mV of ripple could reduce a 14 bit converter to 12 bit performance.**

**Jitter and SNR Calculator for ADCs**

<http://www.ti.com/tool/jitter-snr-calc>



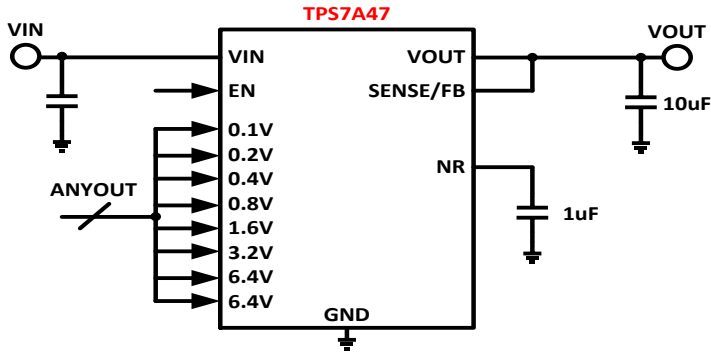
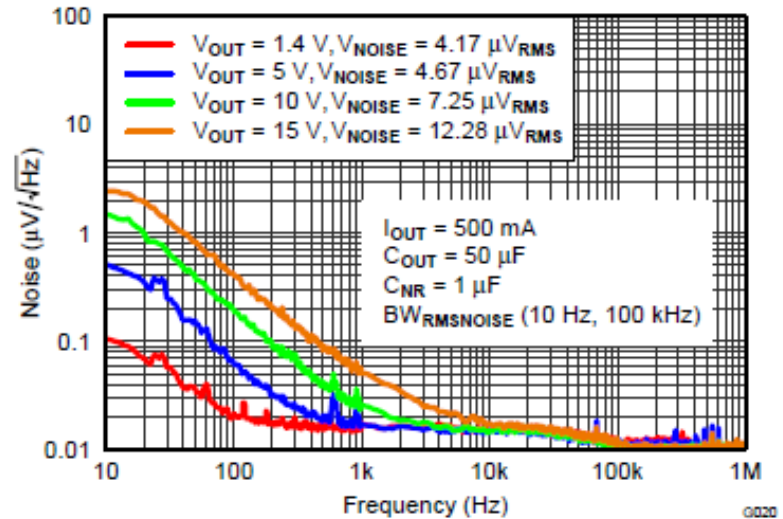


## Solution:

# TI Low Noise LDOs for Signal Chain Power

### TPS7A4700: 36V/1A RF Ultra Low Noise LDO

- $4.17\mu\text{V}_{\text{RMS}}$  10 to 100kHz
- **PSRR**: 82dB @ 10kHz; 82dB @ 100kHz; 55db @ 1MHz;  
**PSRR peak of almost 80dB at 2 MHz**
- Stable with  $\geq 10\mu\text{F}$  ceramic output cap
- **ANYOUT** adjustable from 1.4V - 20.5V
- FB pin adjustable: 1.4V – 34V (TPS7A4701)
- [TPS7A4701-EP](#) version available



**TI Designs**

[PMP8372](#): 40V Dual 1A Power Module w/Low Noise LDOs Split-Rail ( $\pm 5\text{V}$ ) Output Voltages Reference Design

Device	$V_{\text{IN}}$	$I_{\text{OUT}}$	$V_{\text{DO}}$	Package
TPS7A4700/1	3.0V-36V	1A	307mV@1A	5x5mm 20 QFN

# TI LDOs: Low-Noise LDOs ( $\leq 15\mu\text{V}_{\text{RMS}}$ )

Status

Production

Development

		Today	2017
Low-Noise LDOs	>3A	<div data-bbox="330 216 595 314"> <b>TPS7A85</b>                      4A, <math>6\mu\text{V}_{\text{RMS}}</math>                      1.1V-6.5V, 3.5x3.5 QFN                 </div>	
	1A-3A	<div data-bbox="170 353 426 452"> <b>TPS7A83</b>                      2A, <math>6\mu\text{V}_{\text{RMS}}</math>                      1.1V-6.5V, 3.5x3.5 QFN                 </div>	<div data-bbox="488 353 745 452"> <b>TPS7A84A</b>                      3A, <math>6\mu\text{V}_{\text{RMS}}</math>                      1.1V-6.5V, 3.5x3.5 QFN                 </div>
		<div data-bbox="170 473 426 572"> <b>TPS7A47</b>                      1A, <math>4\mu\text{V}_{\text{RMS}}</math>                      3V-36V, 5x5 QFN                 </div>	<div data-bbox="488 473 745 572"> <b>TPS7A89</b>                      Dual, 2A, <math>4\mu\text{V}_{\text{RMS}}</math>                      1.4V-6.5V, 4x4 QFN                 </div>
	0.3A-1A	<div data-bbox="170 615 426 714"> <b>LP38798</b>                      800mA, <math>5\mu\text{V}_{\text{RMS}}</math>                      2V-20V, 4x4 QFN                 </div>	<div data-bbox="488 615 745 714"> <b>TPS7A87/8</b>                      Dual, 0.5A/1A, <math>3.8\mu\text{V}_{\text{RMS}}</math>                      1.4V-6.5V, 4x4 QFN                 </div>
		<div data-bbox="170 746 426 845"> <b>LP5912</b>                      500mA, <math>12\mu\text{V}_{\text{RMS}}</math>                      1.6V-6.5V, 2x2 DFN                 </div>	<div data-bbox="488 746 745 845"> <b>TPS7A91</b>                      1A, <math>3.8\mu\text{V}_{\text{RMS}}</math>                      1.4V-6.5V, 2.5x2.5 DFN                 </div>
$\leq 0.3A$	<div data-bbox="170 877 426 976"> <b>LP5907</b>                      250mA, <math>6\mu\text{V}_{\text{RMS}}</math>                      2.2V-5.5V, 0.65x0.65 CSP                 </div>	<div data-bbox="488 877 745 976"> <b>LP5910</b>                      300mA, <math>12\mu\text{V}_{\text{RMS}}</math>                      1.3-3.3V, 0.75x0.75                 </div>	<div data-bbox="838 877 1095 976"> <b>TPS7A39</b>  <math>\pm\text{IN} \rightarrow \pm\text{OUT}</math>  <math>\pm 150\text{mA}</math>, <math>15\mu\text{V}_{\text{RMS}}</math>  <math>\pm 3\text{V}</math> to <math>\pm 30\text{V}</math>, 3x3 QFN                 </div>

## TI Designs

[TIDA-00388](#): Low noise linear regulator + DC/DC reference design with excellent transient response

[PMP8372](#): 40V Dual 1A Power Module w/Low Noise LDOs Split-Rail ( $\pm 5\text{V}$ ) Output Voltages Reference Design

[TIDA-00270](#): Current-Sharing Dual LDOs – 6A

Visit: [www.ti.com/ldo](http://www.ti.com/ldo)

# Challenge #3: Voltage Regulation Accuracy

As process technology advances, processor voltage requirements are lower and require high accuracy

1. Choose DC/DC with  $V_{ref} \leq 1\%$  accuracy

TPS54020 ELECTRICAL CHARACTERISTICS:					
TJ = -40°C to 150°C, VIN = 4.5V to 17V, PVIN = 4.5V to 17V (unless otherwise noted)					
Parameter	Conditions	Min	Typ	Max	Unit
Voltage Reference	0 A ≤ IOOUT ≤ 10 A, -40°C ≤ TA ≤ 150°C	0.594	0.6	0.606	V

2. Choose tighter tolerance **resistor dividers**

- 0.1% or 0.5% resistors cost more than 1% resistors
- High accuracy for lower voltages is not difficult, since low divider ratios are inherently accurate
- Search "[Kollman Power Tip #18](#)" to learn more about voltage dividers and accuracy

3. A **remote sense** feature in the POL DC/DC converter will compensate for I\*R drops and maintain accuracy

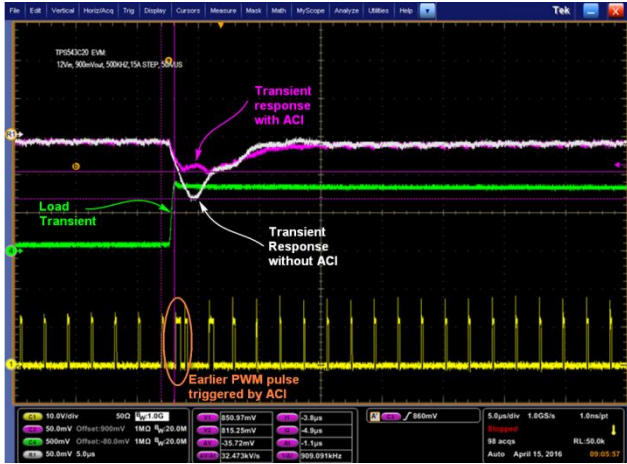
## Recommended Operating Conditions

Symbol	Min	Typ	Max	Units
FPGA Logic				
$V_{CCINT}^{(3)}$	0.97	1.00	1.03	V
	0.87	0.90	0.93	V
$V_{CCBRAM}^{(3)}$	0.97	1.00	1.03	V
	0.87	0.90	1.03	V

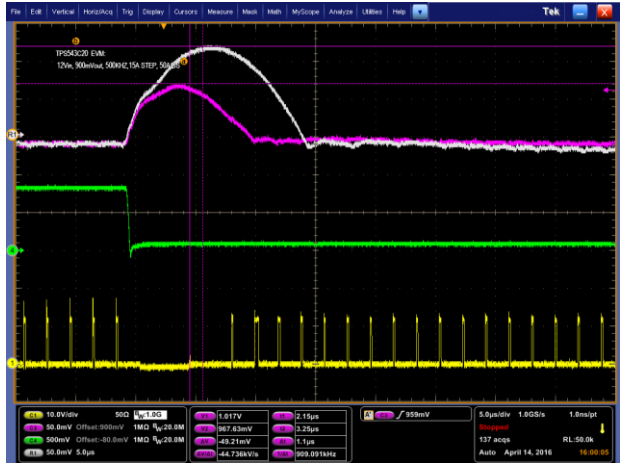


# Solution: Over / Undershoot Improvement

**TPS543C20:** 4Vin to 16Vin, 40A Fixed-Frequency, Stackable Synchronous Step-Down SWIFT™ Converter with Remote Sense, API, and Body Braking for FPGA power



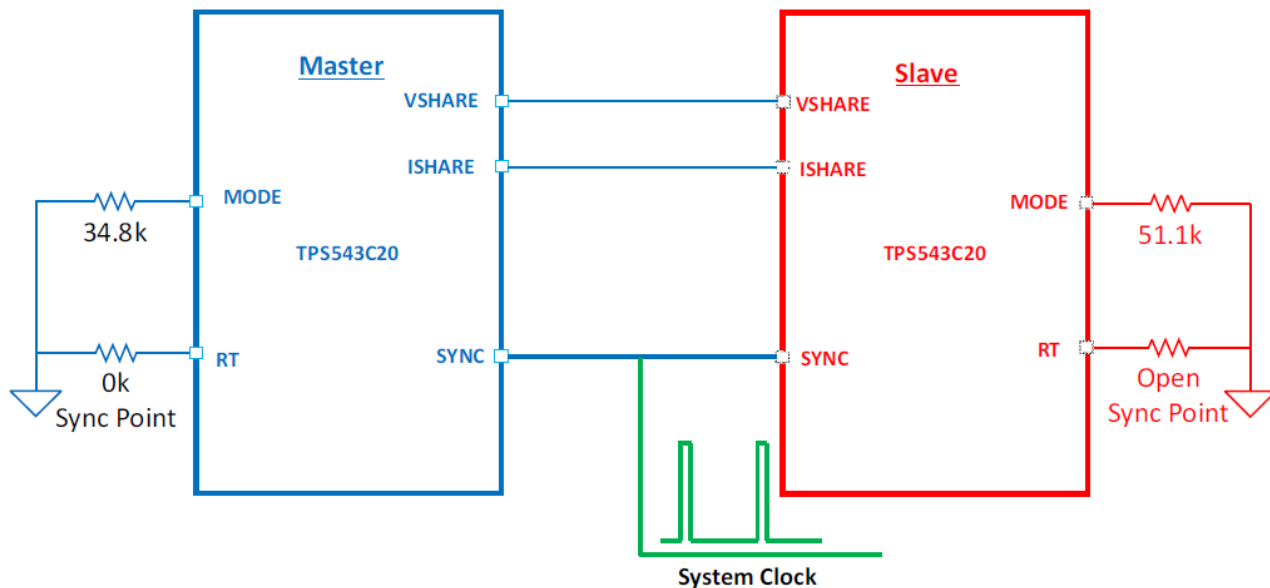
Transient response with and without Asynchronous Pulse Injection (API)



With and without Body Braking

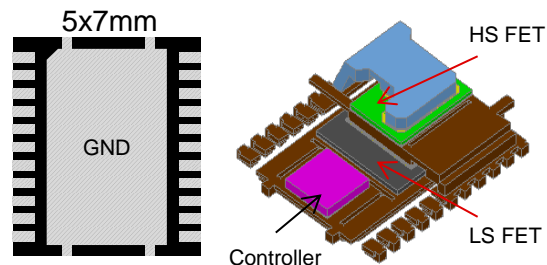
Meet voltage over / undershoot requirements during transient with less capacitance!

# Solution: Up to 80A with Stack-ability



## QFN Package

- 3D for highest power density & lowest  $R_{ds(on)}$
- Highest current capability
- Reduced parasitics
- Large single GND pad versus competition



## Evaluation Modules:

- [TPS543B20 25A EVM](#)
- [TPS543C20 40A EVM](#)
- [TPS543C20 80A EVM](#)

See also the pin-to-pin compatible 25A [TPS543B20](#)

# SWIFT™ Synchronous Buck Converters Portfolio

PMBus w/o Telemetry

Released  
Newly Released

PMBus w/Telemetry

Automotive

Mid Voltage <30V

**TPS54290/1/2**  
Dual 4.5V – 18V Vin, CM  
1.5/2.5A, 4.4x5 HTSSOP

**TPS54424/824**  
4.5-17V, 4A/8A, CM,  
1.5MHz 3.5x3.5mm HR

**TPS54A20**  
8V – 14V Vin, 10A, COT  
Up to 10MHz, 3.5x4 QFN

**TPS549A20**  
4.5-18V Vin, 15A  
D-CAP3, 3.5x4.5 QFN

**TPS543B20**  
4-18V Vin, 25A, 5x7 RVF  
Int. Comp Adv. CM

**TPS543C20**  
4-16V, 2X Stack, 5x7 RVF  
40A, Int. Comp Adv. CM

**TPS54620/22/23**  
4.5–17V, 6A, CM, 1.6MHz  
3.5x3.5mm 14-QFN

**TPS54020**  
4.5V – 17V Vin, 10A  
CM, 3.5x3.5 HR

**TPS548A20**  
4.5-18V Vin, 15A  
D-CAP3, 3.5x4.5 QFN

**TPS549B22**  
4.5-18V Vin, 25A  
D-CAP3, 5x7 QFN

**TPS549D22**  
4.5-16V Vin, 40A  
D-CAP3, 5x7 QFN

**TPS54320**  
4.5V – 17V Vin, 3A  
CM, 3.5x3.5 VQFN

**TPS53513/15**  
4.5V – 18V Vin, 8/12A  
D-CAP3, 3.5x4.5 QFN

**TPS53915**  
4.5V – 18V Vin, 12A  
D-CAP3, 3.5x4.5 QFN


**TPS548B22**  
1.5-18V Vin, 25A  
D-CAP3, 5x7 QFN


**TPS548D22/21**  
1.5-16V Vin, 40A  
D-CAP3, 5x7 QFN


**TPS544B20/C20**  
4.5V – 18V Vin, 20/30A  
D-CAP/D-CAP2, 5x7 QFN

**TPS546C20A/23**  
4.5-15V Vin, 35A  
VM, Stack 2x, 5x7 QFN

Low Voltage ≤6V

**LM26420**  
2.95V – 6V Vin, Dual 2A  
CM, 4x4 QFN 

**TPS57112/114**  
2.95V – 6V Vin, 2/4A  
CM, 3x3 QFN 

**TPS54618/678**  
2.95V – 6V Vin, 6A  
CM, 3x3 QFN 

**TPS54218**  
2.95V – 6V Vin, 2A  
CM, 3x3 QFN

**TPS54318**  
2.95V – 6V Vin, 3A  
CM, 3x3 QFN

**TPS54418/478**  
2.95V – 6V Vin, 4A  
CM, 3x3 QFN

**LM21212**  
2.95V – 5.5V Vin, 12A  
CM, 4.4x6.5 HTSSOP

**LM21215A**  
2.95V – 5.5V Vin, 15A  
CM, 4.4x6.5 HTSSOP

≤ 10A

10A+

Visit: [www.ti.com/swift](http://www.ti.com/swift)

# Solution: Power for FPGAs

Overview Reference Designs **Power** Clocks Data Converter Analog Building Blocks JESD204B Interface Xilinx Boards Videos

## Power for FPGA, processors, and ASICs

With a robust portfolio of LDOs, power modules, DC/DC switchers, and PMICs, TI's easy-to-use solutions - combined with system expertise - support a range of voltages, currents, performance levels, and sizes to form a perfect match with your FPGA.



Overview

Xilinx

Altera

### Find the right TI devices for your Xilinx solution

Family: Artix-7  
 Part Number: XC7A200T  
 Nominal Input Voltage: 12.0V  
 Design Reference: Highest Efficiency  
 Automotive only

Power	Sequence #*	Loads** (Max)	% Loads	Solutions			
				LDO	Module	DC/DC Converter	Controller
Power Supply: #1 Output Voltage: 1V Max Load: 8.670A		VCCINT (8.000A) VCCBRAM (0.080A) MGTAVCC (0.590A)	Low (2.601A)		LMZ31704, 4A LMZ31707, 7A LMZ31506, 6A	TP54824, 8A TP53313, 6A TP53318, 8A	TP540170, 25A LM3150, 15A LM27403, 40A
			Med (5.202A)		LMZ31707, 7A	TP53318, 8A	TP53219A, 25A

Visit:

[www.ti.com/powerfpga](http://www.ti.com/powerfpga)

# Solution: FPGA Power Reference Designs

Tool Number	Tool Title
<a href="#"><u>PMP8251</u></a>	Power Solution for Xilinx FPGA Zynq 7
<a href="#"><u>PMP10520</u></a>	Xilinx Virtex UltraScale FPGA Multi-Gigabit Transceiver (MGT) Power Solution
<a href="#"><u>PMP10555</u></a>	Xilinx Ultrascale 16nm Power Solution with PMBus
<a href="#"><u>PMP6776</u></a>	Xilinx Kintex FPGA Power Solution
<a href="#"><u>PMP9407</u></a>	Xilinx Virtex Ultrascale FPGA Multi-Gigabit Transceiver (MGT) Power Reference Design with PMBus
<a href="#"><u>TIDA-00432</u></a>	Synchronization of JESD204B Giga-Sample ADCs w/Xilinx for Phased Array Radar Systems
<a href="#"><u>PMP11328</u></a>	30A PMBus Reference Design for Xilinx Zynq Ultrascale+ ZU9EG MPSoC Core Rail
<a href="#"><u>PMP9357</u></a>	Altera Arria V FPGA Power Supply Reference Design
<a href="#"><u>PMP5006</u></a>	20V Input Sync Buck Designs to Power Altera Arria GXII
<a href="#"><u>PMP2543</u></a>	Altera Cyclone III FPGA Power Management Reference Design
<a href="#"><u>PMP8824</u></a>	7 to 12Vin 1.2Vout 8A Step-down Conv for Powering Rails in Altera Arria V FPGA Reference Design

- Test report, BOM, schematic, design files, and test report. Search Tool Number
- Visit [www.ti.com/tidesigns](http://www.ti.com/tidesigns) to see a complete searchable design list



# Challenge #4: High Power Density with GaN

## Advantages of TI GaN over Discrete GaN

- **Easy System Design**
  - Optimized Integrated driver with zero common-source inductance enables high-speed low loss switching
  - Regulated gate drive bias provides reliable GaN switching
  - Low inductance package reduces power loop ringing
  - Ease of board layout
- **Higher Efficiency**
  - ZERO reverse-recovery losses in hard-switched, half-bridge converters
  - Low output capacitance,  $C_{oss}$
  - Low switch ringing
- **Ecosystem**
  - Complete range of digital and analog controllers, and complementary analog and power solutions
- **Reliability**
  - Over 3 million device hour of application reliability testing beyond JEDEC



Simplify the  
Design



Save Time and  
Resources

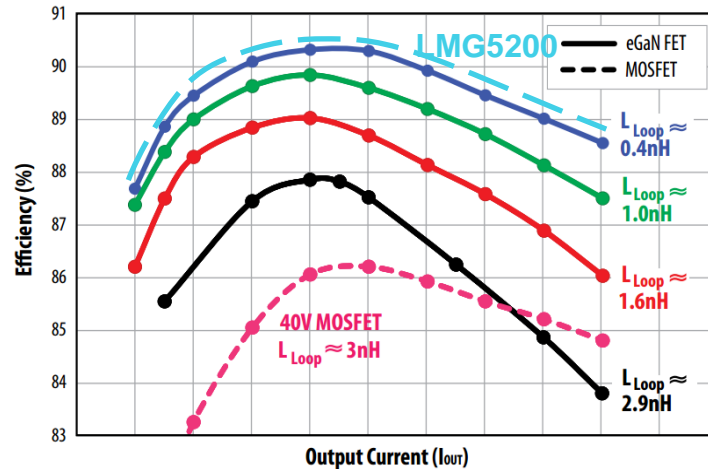
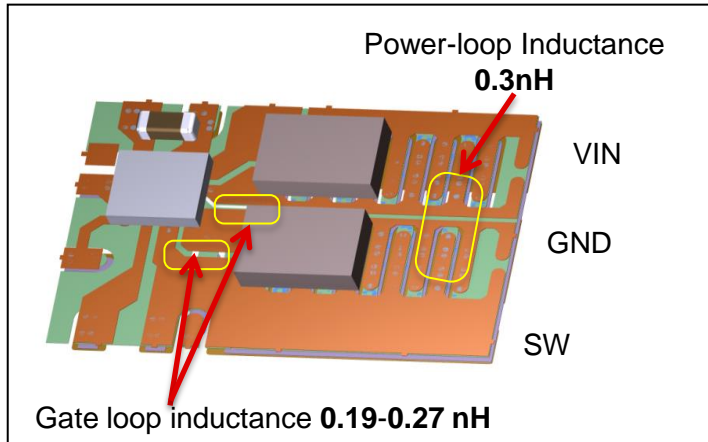


Improve system  
performance

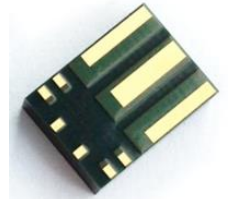
Find out more at [www.ti.com/GaN](http://www.ti.com/GaN)

# LMG5200: 80V/10A GaN Power Stage

- Although MV GaN has been in production for a number of years, the LMG5200 Power Stage removes barriers to GaN design:
  - Removed driver design complexity – We can call it *Digital-GaN*
  - Minimal drive and power loop inductance – Get the *real performance* of the GaN
  - Robust QFN package – Something power designers *know and trust*.



6x8mm QFN



EVMs and SPICE Models Available

Find out more at [www.ti.com/GaN](http://www.ti.com/GaN)

# PMP4497 GaN Module 48V to 1V 40A Converter

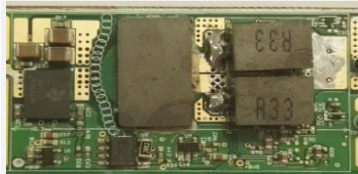
## Features

- Extra high Efficiency up to 89.9% @1.0V/40A
- 600kHz ~ 1MHz operation frequency
- LMG5200 GaN FET module
- DCAP+ Controlling with the TPS53632G
- Half-Bridge Isolated with Current-Doubler topology
- One stage to replace the traditional two-stage solution

## Benefits

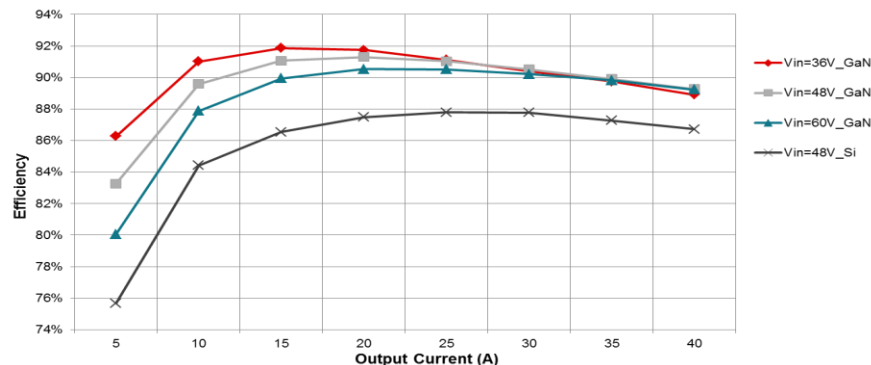
- Extra higher efficiency comparing with two stage solution
- High power density with up to 1/3 foot print reduced
- Less components
- Isolated design

## Tools & Resources



- **PMP4497 Tools Folder**
- **Design Files: Schematics, testing report, BOM, Gerber and more**
- **Device Datasheets:**
  - [LMG5200](#)
  - [TPS53632G](#)
  - [ISO7420FEDR](#)
  - [TLV70450DBVR](#)
  - [TLV70433DBVR](#)
  - [UCC27512DRSR](#)

Efficiency Curve With Driver Loss vs. Vin @600kHz



Find out more at [www.ti.com/GaN](http://www.ti.com/GaN)

# New GaN Devices and Solutions

- [LMG5200](#): 80V GaN Power Stage Solution
- [LMG3410](#): 600V GaN Power Stage with Smart Direct-Drive
- [LM5113](#): Half-Bridge 100V GaN Gate Driver
- [LMG1205](#): 100-V, 1.2-A, 5-A, Half-Bridge Gate Driver
- [PMP4497](#): TI Design: 48V to 1V/40A Converter
- [PMP20289](#): TI Design: 400Vin, 12V/500W LLC
- [TIDA-00909](#): TI Design: 48V/10A High Frequency 3-Phase Motor Drive

Find out more at [www.ti.com/GaN](http://www.ti.com/GaN)

# Challenge #5: Finding Enhanced Products

## Enhanced Products offer:

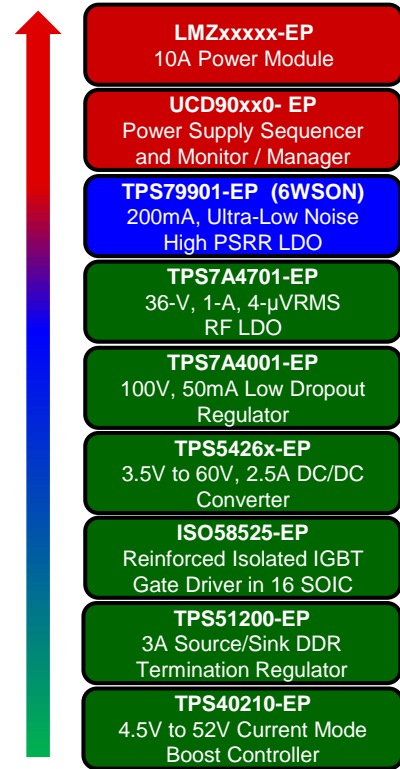
- Controlled Baseline
- Extended Temp range (i.e. -55C to +125C)
- No pure Sn bond pads or Cu bond wires
- Extended PCN notifications
- Qualification & Reliability reports
- Product traceability

## Power Products & Links:

- [Enhanced Products Web Page](#)
- [Enhanced Products \(EP\) Guide](#)
- [Enhanced Products \(EP\) Listing](#)

Concept  
Development

Recently  
Released



## Challenge #6:

# Simulating your power design

- Search for a performance power device or solution
- Simulation design tools
- Reference designs, samples & evaluation modules
- Support

# Solution: Download TI Designs



Search TI Designs Search power designs by parameters

Search reference designs by application or product type

Contact the TI Designs team

Find your solution now

dsp power

8 Results Results per Page 10

Search power reference design parameters

Applications

Industrial   
Space, Avionics & Defense

- Avionics
- Naval Defense
- Other Space, Avionics & Defense
- Radios
- Smart Munitions
- Space

View 8 designs

Products

Additional resources

## Optimized Radar System Reference Design Using a DSP+ARM SoC

TI Designs  
Updated: 22 MAR 2017

### Description

For modern radar system developers currently using an FPGA or ASIC to connect to high speed data converters, who need faster time to market with increased performance and significant reduction in cost, power, and size, this reference design includes the first widely available processor integrating a (...)

### Key Features

- Easy integration of signal processor to data converters over JESD204B
- Sampling of a single 100MHz channel, when connected to ADC14X250
- DFE processing for filtering, down-sampling or up-sampling; FFTC hardware accelerator to offload compute-intensive 2D FFT operations, achieving low latency and high (...)

### Available resources

- 
- 
- 
- 
- 

### TI Devices

66AK2L06  
ADC14X250  
DAC38J84  
LMK04828



### Applications Matched

- Industrial
- Space, Avionics & Defense

## Wideband Receiver Design Using 66AK2L06 JESD204B Attach to ADC32RF80 Reference Design

TI Designs  
Updated: 06 OCT 2016

### Description

For wideband receiver system developers currently using FPGA or ASIC to connect High Speed data converters to a baseband processor, who

### Available resources

- 



## TI Designs Contain

- Schematic
- Bill of Materials
- Test Report
- Design Files

Search by Power Supply Parameters, Application, or by Product

[www.ti.com/tidesigns](http://www.ti.com/tidesigns)

# Solution: Webench® Power Architect

- Helps select the best part and completes the design by selecting components based on design criteria
- Start design by entering  $V_{in}$ / $V_{out}$ / $I_{out}$  and other criteria in advanced options
- Allows the design to be optimized, edited, exported, simulated, and more
- If unencrypted PSPICE models are needed, please contact TI

Advanced Options

**Multiple Outputs**

Vout2: 0 V Iout2: 0 A  
Vout3: 0 V Iout3: 0 A

**Nominal Operating Inputs**

Vin1 Operating: 8V < V < 17V  
Iout1 Operating: A < 6A  
 Rank solutions based on performance at nominal operating inputs

**Design Control**

**Frequency Controls**

Adjustable Frequency (±5%)  
 External SYNC Frequency  
 None

Softstart: ms

Max Peak to Peak Vout Ripple: %  
Max Peak to Peak Inductor Ripple: %

Add Post Ripple Filter  
 Show Alternate Topologies (Flyback, Buck/Boost, etc.)  
 Add Input Ripple Filter

**Component Selection**

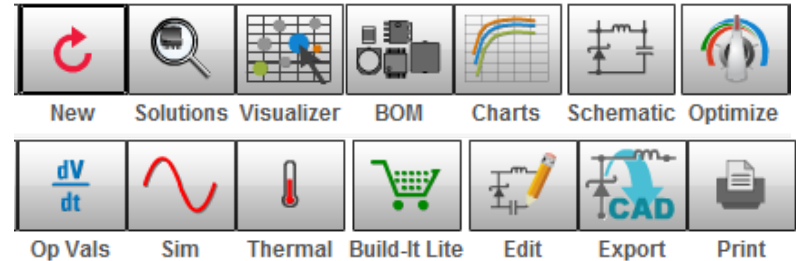
**Minimum Package**

Min Type: Select  
Min Area: mm²  
Max Component Height: mm

Cap Selection:  Ceramic Only  
Inductor Selection:  Shielded Only  
 Use only TI FET  
 Synchronous FET Pairing (Prefer)  
Preferred Distributor: Select

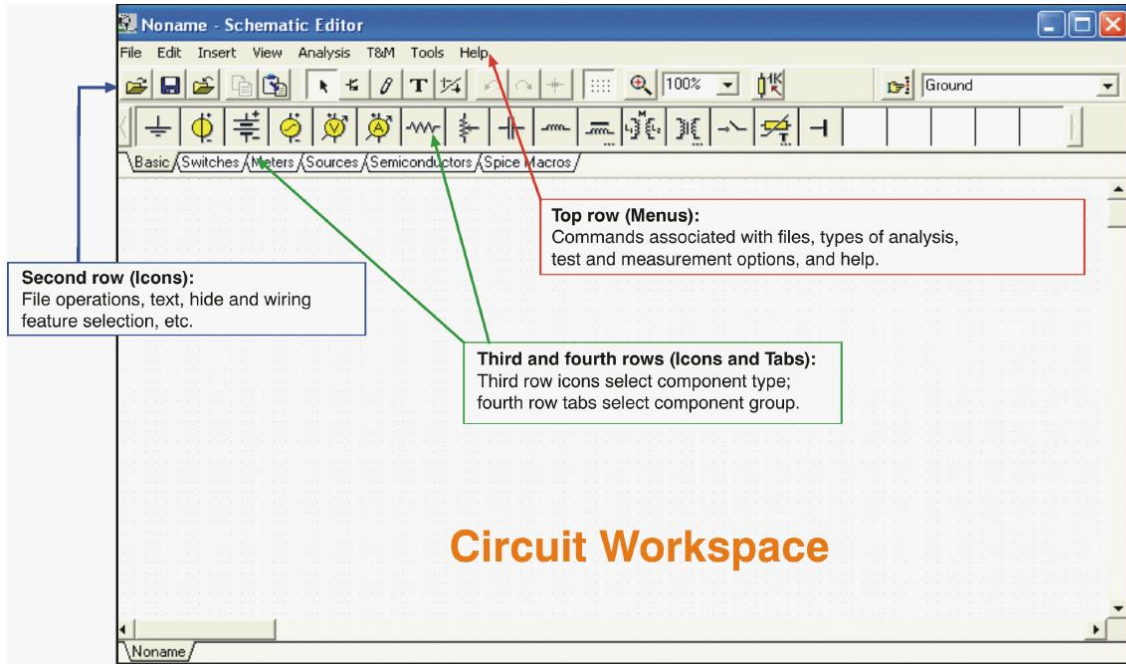
Use Only Components In Stock  
 Use Components with Price  
 Use Components for Build-it kit (Prototype)  
 Use Components from US Suppliers only

Solution Sort Settings





# Solution: TI TINA



- Spice-based analog simulation program
- Develop, test, and simulate circuit ideas
- Supports Analog and SMPS circuits
- Simple and intuitive graphics-based interface
- Quick Start Guide available here:

<http://www.ti.com/lit/pdf/sbou052>

Download TI-TINA: <http://www.ti.com/tool/tina-ti>

# New App Notes and Other Technical Literature

- A Topical Index of TI LDO Application Notes - SBVA026
  - <http://www.ti.com/general/docs/lit/getliterature.tsp?baseLiteratureNumber=sbva026>
- LDO Noise Demystified – SLAA412A
  - <http://www.ti.com/general/docs/lit/getliterature.tsp?baseLiteratureNumber=slaa412&fileType=pdf>
- Control mode quick reference guide – SLYT710A
  - <http://www.ti.com/general/docs/lit/getliterature.tsp?baseLiteratureNumber=slyt710>
- Innovative DC/DC Power Modules Guide – SLYT685
  - <http://www.ti.com/general/docs/lit/getliterature.tsp?baseLiteratureNumber=slyt685>
- A comprehensive methodology to qualify the reliability of GaN products – SLYY070
  - <http://www.ti.com/general/docs/lit/getliterature.tsp?baseLiteratureNumber=slyy070>

# Conclusion

- Power for Defense and Aerospace applications is challenging and TI has the power solutions!
- TI power converters provide a high density, high performance power solution ideal for processors
- TI low noise LDOs provide clean power for data converters
- TI has tools and resources to simplify your power designs

Thank you!